Cyclone V Device Overview

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The Cyclone[®] V devices are designed to simultaneously accommodate the shrinking power consumption, cost, and time-to-market requirements; and the increasing bandwidth requirements for high-volume and cost-sensitive applications.

Enhanced with integrated transceivers and hard memory controllers, the Cyclone V devices are suitable for applications in the industrial, wireless and wireline, military, and automotive markets.

Related Information

Cyclone V Device Handbook: Known Issues

Lists the planned updates to the *Cyclone V Device Handbook* chapters.

Key Advantages of Cyclone V Devices

Table 1: Key Advantages of the Cyclone V Device Family

Advantage	Supporting Feature				
Lower power consumption	 Built on TSMC's 28 nm low-power (28LP) process technology and includes an abundance of hard intellectual property (IP) blocks Up to 40% lower power consumption than the previous generation device 				
Improved logic integration and differentiation capabilities	 8-input adaptive logic module (ALM) Up to 13.59 megabits (Mb) of embedded memory Variable-precision digital signal processing (DSP) blocks 				
Increased bandwidth capacity	 3.125 gigabits per second (Gbps) and 6.144 Gbps transceivers Hard memory controllers 				
Hard processor system (HPS) with integrated ARM® Cortex [™] -A9 MPCore processor	 Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Cyclone V system-on-a-chip (SoC) Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric 				

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Advantage	Supporting Feature
Lowest system cost	 Requires only two core voltages to operate Available in low-cost wirebond packaging Includes innovative features such as Configuration via Protocol (CvP) and partial reconfiguration

Summary of Cyclone V Features

Table 2: Summary of Features for Cyclone V Devices

Feature		Description						
Technology	• TSMC's 28-nm lov • 1.1 V core voltage	 TSMC's 28-nm low-power (28LP) process technology 1.1 V core voltage 						
Packaging	 Wirebond low-halogen packages Multiple device densities with compatible package footprints for seamless migration between different device densities RoHS-compliant and leaded⁽¹⁾options 							
High-performance FPGA fabric	Enhanced 8-input AL	Enhanced 8-input ALM with four registers						
Internal memory blocks	 M10K—10-kilobits (Kb) memory blocks with soft error correction code (ECC) Memory logic array block (MLAB)—640-bit distributed LUTRAM where you can use up to 25% of the ALMs as MLAB memory 							
Embedded Hard IP blocks	 Variable-precision DSP Native support for up to three signal processing precision levels (three 9 x 9, two 18 x 18, or one 27 x 27 multiplier) the same variable-precision DSP block 64-bit accumulator and cascade Embedded internal coefficient memory Preadder/subtractor for improved efficiency 							
	Memory controller	DDR3, DDR2, and LPDDR2 with 16 and 32 bit ECC support						
	Embedded transceiver I/O	PCI Express® (PCIe®) Gen2 and Gen1 (x1, x2, or x4) hard IP with multifunction support, endpoint, and root port						
Clock networks	 Up to 550 MHz global clock network Global, quadrant, and peripheral clock networks Clock networks that are not used can be powered down to reduce dynamic power 							

 $^{^{(1)}}$ Contact Altera for availability.



Feature	Description
Phase-locked loops (PLLs)	 Precision clock synthesis, clock delay compensation, and zero delay buffering (ZDB) Integer mode and fractional mode
FPGA General- purpose I/Os (GPIOs)	 875 megabits per second (Mbps) LVDS receiver and 840 Mbps LVDS transmitter 400 MHz/800 Mbps external memory interface On-chip termination (OCT) 3.3 V support with up to 16 mA drive strength
Low-power high- speed serial interface	 614 Mbps to 6.144 Gbps integrated transceiver speed Transmit pre-emphasis and receiver equalization Dynamic partial reconfiguration of individual channels
HPS (Cyclone V SE, SX, and ST devices only)	 Single or dual-core ARM Cortex-A9 MPCore processor-up to 925 MHz maximum frequency with support for symmetric and asymmetric multiprocessing Interface peripherals—10/100/1000 Ethernet media access control (EMAC), USB 2.0 On-The-GO (OTG) controller, quad serial peripheral interface (QSPI) flash controller, NAND flash controller, Secure Digital/MultiMediaCard (SD/MMC) controller, UART, controller area network (CAN), serial peripheral interface (SPI), I²C interface, and up to 85 HPS GPIO interfaces System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers On-chip RAM and boot ROM HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa FPGA-to-HPS SDRAM controller subsystem—provides a configurable interface to the multiport front end (MPFE) of the HPS SDRAM controller ARM CoreSight™ JTAG debug access port, trace port, and on-chip trace storage
Configuration	 Tamper protection—comprehensive design protection to protect your valuable IP investments Enhanced advanced encryption standard (AES) design security features CvP Partial and dynamic reconfiguration of the FPGA Active serial (AS) x1 and x4, passive serial (PS), JTAG, and fast passive parallel (FPP) x8 and x16 configuration options



Cyclone V Device Variants and Packages

Table 3: Device Variants for the Cyclone V Device Family

Variant	Description
Cyclone V E	Optimized for the lowest system cost and power requirement for a wide spectrum of general logic and DSP applications
Cyclone V GX	Optimized for the lowest cost and power requirement for 614 Mbps to 3.125 Gbps transceiver applications
Cyclone V GT	The FPGA industry's lowest cost and lowest power requirement for 6.144 Gbps transceiver applications
Cyclone V SE	SoC with integrated ARM-based HPS
Cyclone V SX	SoC with integrated ARM-based HPS and 3.125 Gbps transceivers
Cyclone V ST	SoC with integrated ARM-based HPS and 6.144 Gbps transceivers

Cyclone V E

This section provides the available options, maximum resource counts, and package plan for the Cyclone V E devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

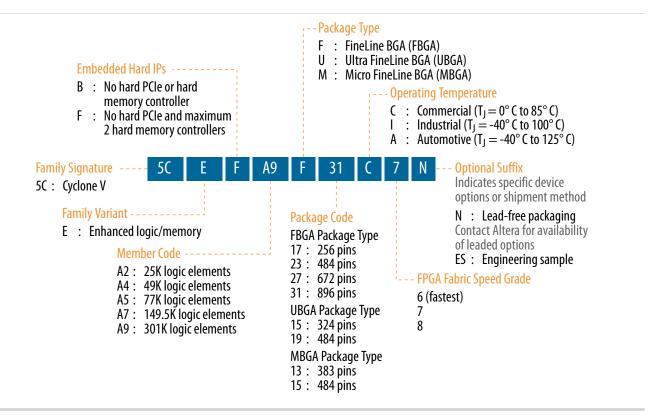
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Available Options

Figure 1: Sample Ordering Code and Available Options for Cyclone V E Devices



Maximum Resources

Table 4: Maximum Resource Counts for Cyclone V E Devices

Poso	Resource		Member Code							
Neso	uice	A2	A4	A5	A7	A9				
Logic Elem	ents (LE) (K)	25	49	77	149.5	301				
ALM		9,434	18,480	29,080	56,480	113,560				
Register	Register		73,920	116,320	225,920	454,240				
Memory	M10K	1,760	3,080	4,460	6,860	12,200				
(Kb)	MLAB	196	303	424	836	1,717				
Variable-pi Block	Variable-precision DSP Block		66	150	156	342				
18 x 18 Mu	18 x 18 Multiplier		132	300	312	684				
PLL		4	4	6	7	8				
GPIO		224	224	240	480	480				



Resource		Member Code						
		A2	A4	A5	A7	A9		
LVDS	Transmitter	56	56	60	120	120		
	Receiver	56	56	60	120	120		
Hard Memory Controller		1	1	2	2	2		

Related Information

I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.

Package Plan

Table 5: Package Plan for Cyclone V E Devices

Member Code	M383 (13 mm)	M484 (15 mm)	U324 (15 mm)	F256 (17 mm)	U484 (19 mm)	F484 (23 mm)	F672 (27 mm)	F896 (31 mm)
	GPIO							
A2	223	_	176	128	224	224	_	_
A4	223	_	176	128	224	224	_	_
A5	175	_	_	_	224	240	_	_
A7	_	240	_	_	240	240	336	480
A9	_	_	_	_	240	224	336	480

Cyclone V GX

This section provides the available options, maximum resource counts, and package plan for the Cyclone V GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

Altera Product Selector

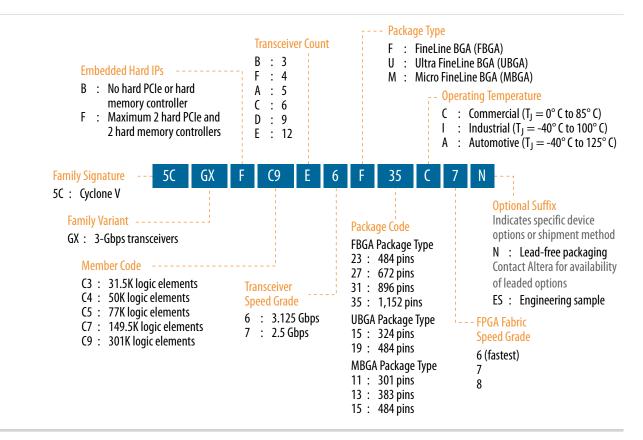
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Available Options

The following figure shows sample ordering code and lists the options available for Cyclone V GX devices.



Figure 2: Sample Ordering Code and Available Options for Cyclone V GX Devices



Maximum Resources

Table 6: Maximum Resource Counts for Cyclone V GX Devices

Poso	Resource		Member Code							
neso	ource	C3	C4	C5	C 7	C 9				
Logic Elem	nents (LE) (K)	35.5	50	77	149.7	301				
ALM		13,460	18,860	29,080	56,480	113,560				
Register	Register		75,440	116,320	225,920	454,240				
Memory	M10K	1,350	2,500	4,460	6,860	12,200				
(Kb)	MLAB	291	678	678	1,338	2,748				
Variable-p Block	recision DSP	57	70	150	156	342				
18 x 18 Mu	ıltiplier	114	140	300	312	684				
PLL	PLL		6	6	7	8				
3 Gbps Tra	3 Gbps Transceiver		6	6	9	12				
GPIO ⁽²⁾		208	336	336	480	560				



Pos	Resource		Member Code							
nesource		C3	C4	C5	C 7	C 9				
LVDS	Transmitter	52	84	84	120	140				
LVDS	Receiver	52	84	84	120	140				
PCIe Hard	PCIe Hard IP Block		2	2	2	2				
Hard Memory Controller		1	2	2	2	2				

Related Information

I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.

Package Plan

Table 7: Package Plan for Cyclone V GX Devices

Member Code	I (II mm)		M383 (13 mm)		M484 (15 mm)		U324 (15 mm)		U484 (19 mm)	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
C3	_	_	_	_	_	_	144	3	208	3
C4	129	4	175	6	_	_	_	_	224	6
C5	129	4	175	6	_	_	_	_	224	6
C7	_	_	_	_	240	3	_	_	240	6
C9	_	_	_	_	_	_	_	_	240	5

Member Code	F484 (23 mm)		F672 (27 mm)		F896 (31 mm)		F1152 (35 mm)	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
C3	208	3	_	_	_	_	_	_
C4	240	6	336	6	_	_	_	_
C5	240	6	336	6	_	_	_	_
C7	240	6	336	9	480	9	_	_
C9	224	6	336	9	480	12	560	12

Cyclone V GT

This section provides the available options, maximum resource counts, and package plan for the Cyclone V GT devices.



⁽²⁾ The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

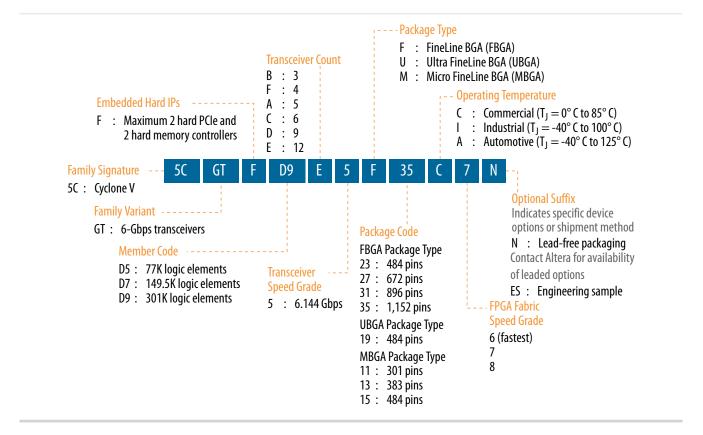
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Available Options

The following figure shows sample ordering code and lists the options available for Cyclone V GT devices.

Figure 3: Sample Ordering Code and Available Options for Cyclone V GT Devices



Maximum Resources

Table 8: Maximum Resource Counts for Cyclone V GT Devices

Docovingo		Member Code				
nesc	Resource		D7	D9		
Logic Elements (Logic Elements (LE) (K)		77 149.5			
ALM	ALM		56,480	113,560		
Register	Register		225,920	454,240		
Memory (Kb)	M10K	4,460	6,860	12,200		
wichioly (Kb)	MLAB	424	836	1,717		



Resource		Member Code			
ne	source	D5	D7	D9	
Variable-preci	sion DSP Block	150	156	342	
18 x 18 Multip	lier	300	312	684	
PLL	PLL		7	8	
6 Gbps Transc	eiver	6	9	12	
GPIO ⁽³⁾		336	480	560	
LVDS	Transmitter	84	120	140	
LVD3	Receiver	84	120	140	
PCIe Hard IP	Block	2	2	2	
Hard Memory	Controller	2	2	2	

Related Information

I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.

Package Plan

Table 9: Package Plan for Cyclone V GT Devices

Member Code	M301 (11 mm)		M383 (13 mm)		M484 (15 mm)		U484 (19 mm)	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
D5	129	4	175	6	_	_	224	6
D7	_	_	_	_	240	3	240	6
D9	_	_	_	_	_	_	240	5
Member Code			F672 F896 (27 mm) (31 mm)		F1152 (35 mm)			
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
D5	240	6	336	6	_	_	_	_
D7	240	6	336	9 (4)	480	9 (4)	_	_
D9	224	6	336	9 (4)	480	12 (5)	560	12 (5)

⁽³⁾ The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os.



⁽⁴⁾ If you require CPRI (at 6.144 Gbps) and PCIe Gen2 transmit jitter compliance, Altera recommends that you use only up to three full-duplex transceiver channels for CPRI, and up to six full-duplex channels for PCIe Gen2. The CMU channels are not considered full-duplex channels.

Cyclone V SE

This section provides the available options, maximum resource counts, and package plan for the Cyclone V SE devices.

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Related Information

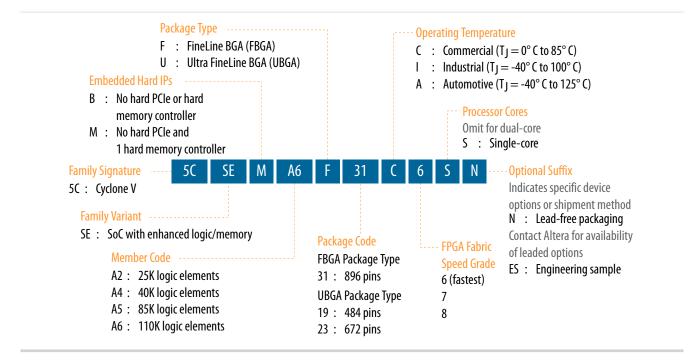
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Available Options

The following figure shows sample ordering code and lists the options available for Cyclone V SE devices.

Figure 4: Sample Ordering Code and Available Options for Cyclone V SE Devices



Send Feedback

⁽⁵⁾ If you require CPRI (at 6.144 Gbps) and PCIe Gen2 transmit jitter compliance, Altera recommends that you use only up to three full-duplex transceiver channels for CPRI, and up to eight full-duplex channels for PCIe Gen2. The CMU channels are not considered full-duplex channels.

Maximum Resources

Table 10: Maximum Resource Counts for Cyclone V SE Devices

Resource		Member Code					
nesc	ource	A2	A4	A 5	A6		
Logic Eleme	ents (LE) (K)	25	40	85	110		
ALM		9,434	15,094	32,075	41,509		
Register		37,736	60,376	128,300	166,036		
Memory	M10K	1,400	2,700	3,970	5,570		
(Kb)	MLAB	138	231	480	621		
Variable-pr Block	ecision DSP	36	84	87	112		
18 x 18 Mul	tiplier	72	168	174	224		
FPGA PLL	FPGA PLL		5	6	6		
HPS PLL	HPS PLL		3	3	3		
FPGA GPIO)	145	145	288	288		
HPS I/O		181	181	181	181		
LVDS	Transmitter	32	32	72	72		
LVDS	Receiver	37	37	72	72		
FPGA Hard Controller	Memory	1	1	1	1		
HPS Hard I Controller	HPS Hard Memory Controller		1	1	1		
ARM Corte Processor	x-A9 MPCore	Single- or dual-core	Single- or dual-core	Single- or dual- core	Single- or dual-core		

Related Information

I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.

Package Plan

Table 11: Package Plan for Cyclone V SE Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	U484 (19 mm)			mm)	F896 (31 mm)	
	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O
A2	66	151	145	181	_	_



Member Code	U484 (19 mm)		U672 (23 mm)		F896 (31 mm)	
	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O
A4	66	151	145	181	_	_
A5	66	151	145	181	288	181
A6	66	151	145	181	288	181

Cyclone V SX

This section provides the available options, maximum resource counts, and package plan for the Cyclone V SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

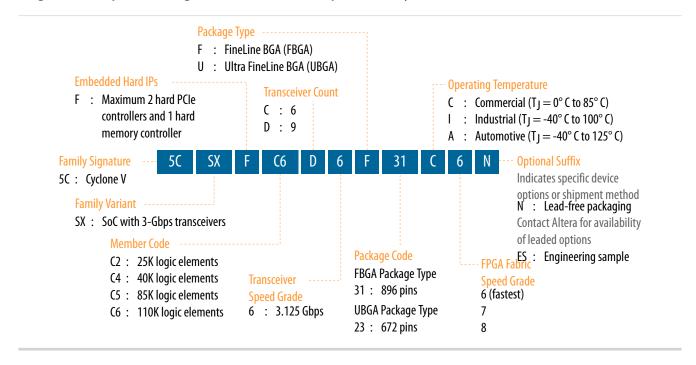
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Available Options

The following figure shows sample ordering code and lists the options available for Cyclone V SX devices.

Figure 5: Sample Ordering Code and Available Options for Cyclone V SX Devices





Maximum Resources

Table 12: Maximum Resource Counts for Cyclone V SX Devices

Poss	Resource		Me	ember Code	
Reso	Jurce	C2	C4	C5	C6
Logic Elemen	nts (LE) (K)	25	40	85	110
ALM		9,434	15,094	32,075	41,509
Register		37,736	60,376	128,300	166,036
Memory	M10K	1,400	2,700	3,970	5,570
(Kb)	MLAB	138	231	480	621
Variable-pre	cision DSP Block	36	84	87	112
18 x 18 Mult	iplier	72	168	174	224
FPGA PLL	FPGA PLL		5	6	6
HPS PLL	HPS PLL		3	3	3
3 Gbps Trans	sceiver	6	6	9	9
FPGA GPIO	(6)	145	145	288	288
HPS I/O		181	181	181	181
LVDS	Transmitter	32	32	72	72
LVDS	Receiver	37	37	72	72
PCIe Hard II	P Block	2	2	2 (7)	2 (7)
FPGA Hard Controller	FPGA Hard Memory Controller		1	1	1
HPS Hard M Controller	HPS Hard Memory Controller		1	1	1
ARM Cortex Processor	-A9 MPCore	Dual-core	Dual-core	Dual-core	Dual-core

Related Information

I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.



⁽⁶⁾ The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os.

 $^{^{\}scriptscriptstyle{(7)}}\,$ 1 PCIe Hard IP Block in U672 package.

Package Plan

Table 13: Package Plan for Cyclone V SX Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

	U672 (23 mm)			F896			
Member Code				(31 mm)			
	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR	
C2	145	181	6	_	_	_	
C4	145	181	6	_	_	_	
C5	145	181	6	288	181	9	
C6	145	181	6	288	181	9	

Cyclone V ST

This section provides the available options, maximum resource counts, and package plan for the Cyclone V ST devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

Related Information

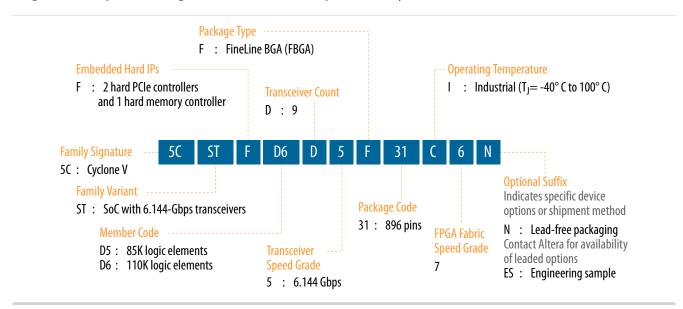
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Available Options

The following figure shows sample ordering code and lists the options available for Cyclone V ST devices.

Figure 6: Sample Ordering Code and Available Options for Cyclone V ST Devices





Maximum Resources

Table 14: Maximum Resource Counts for Cyclone V ST Devices

David		Member Code			
Kesc	ource	D5	D6		
Logic Elements (LE)	(K)	85	110		
ALM		32,075	41,509		
Register		128,300	166,036		
Memory (Kb)	M10K	3,970	5,570		
Memory (Ro)	MLAB	480	621		
Variable-precision D	SP Block	87	112		
18 x 18 Multiplier	18 x 18 Multiplier		224		
FPGA PLL	FPGA PLL		6		
HPS PLL		3	3		
6.144 Gbps Transceiv	ver	9	9		
FPGA GPIO ⁽⁸⁾		288	288		
HPS I/O		181	181		
LVDS	Transmitter	72	72		
LVDS	Receiver	72	72		
PCIe Hard IP Block		2	2		
FPGA Hard Memory	Controller	1	1		
HPS Hard Memory (Controller	1	1		
ARM Cortex-A9 MP	Core Processor	Dual-core	Dual-core		

Related Information

I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.



⁽⁸⁾ The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os.

Package Plan

Table 15: Package Plan for Cyclone V ST Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

		F89	6		
Member Code	(31 mm)				
	FPGA GPIO	HPS I/O	XCVR		
D5	288	181	9 (9)		
D6	288	181	9 (9)		

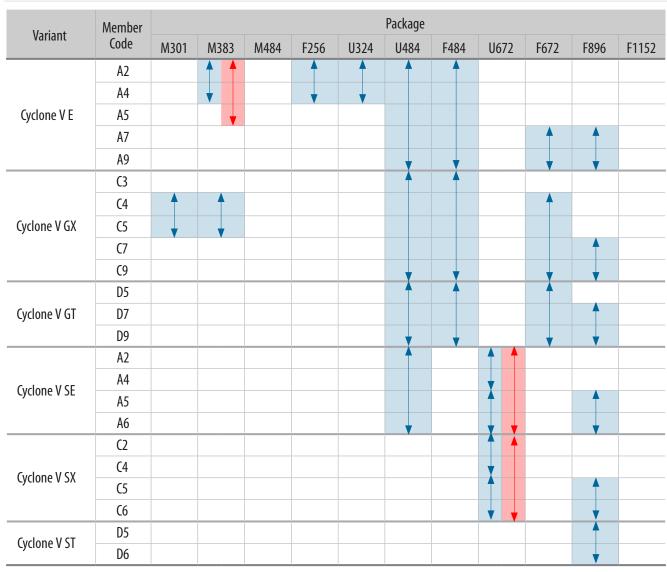


⁽⁹⁾ If you require CPRI (at 4.9152 Gbps) and PCIe Gen2 transmit jitter compliance, Altera recommends that you use only up to seven full-duplex transceiver channels for CPRI, and up to six full-duplex channels for PCIe Gen2. The CMU channels are not considered full-duplex channels.

I/O Vertical Migration for Cyclone V Devices

Figure 7: Vertical Migration Capability Across Cyclone V Device Packages and Densities

The arrows indicate the vertical migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.



You can achieve the vertical migration shaded in red if you use only up to 175 GPIOs for the M383 package, and 138 GPIOs for the U672 package. These migration paths are not shown in the Quartus[®] II software Pin Migration View.

Note: To verify the pin migration compatibility, use the Pin Migration View window in the Quartus II software Pin Planner.

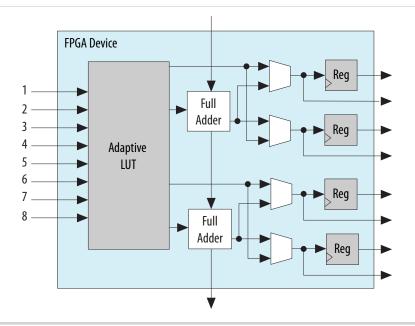


Adaptive Logic Module

Cyclone V devices use a 28 nm ALM as the basic building block of the logic fabric.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than previous generations.

Figure 8: ALM for Cyclone V Devices



You can configure up to 25% of the ALMs in the Cyclone V devices as distributed memory using MLABs.

Related Information

Embedded Memory Capacity in Cyclone V Devices on page 22

Lists the embedded memory capacity for each device.

Variable-Precision DSP Block

Cyclone V devices feature a variable-precision DSP block that supports these features:

- Configurable to support signal processing precisions ranging from 9 x 9, 18 x 18 and 27 x 27 bits natively
- A 64-bit accumulator
- A hard preadder that is available in both 18- and 27-bit modes
- Cascaded output adders for efficient systolic finite impulse response (FIR) filters
- Internal coefficient register banks, 8 deep, for each multiplier in 18- or 27-bit mode
- Fully independent multiplier operation



- A second accumulator feedback register to accommodate complex multiply-accumulate functions
- Fully independent Efficient support for single-precision floating point arithmetic
- The inferability of all modes by the Quartus II design software

Table 16: Variable-Precision DSP Block Configurations for Cyclone V Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resource
Low precision fixed point for video applications	Three 9 x 9	1
Medium precision fixed point in FIR filters	Two 18 x 18	1
FIR filters and general DSP usage	Two 18 x 18 with accumulate	1
High precision fixed- or floating-point implementations	One 27 x 27 with accumulate	1

You can configure each DSP block during compilation as independent three 9 x 9, two 18 x 18, or one 27×27 multipliers. With a dedicated 64 bit cascade bus, you can cascade multiple variable-precision DSP blocks to implement even higher precision DSP functions efficiently.

Table 17: Number of Multipliers in Cyclone V Devices

The table lists the variable-precision DSP resources by bit precision for each Cyclone V device.

Variant	Variable- Member precision			dent Input and		18 x 18 Multiplier	18 x 18 Multiplier Adder
	Code	DSP Block	9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	Adder Mode	Summed with 36 bit Input
	A2	25	75	50	25	25	25
	A4	66	198	132	66	66	66
Cyclone V E	A5	150	450	300	150	150	150
	A7	156	468	312	156	156	156
	A9	342	1,026	684	342	342	342
	C3	57	171	114	57	57	57
	C4	70	210	140	70	70	70
Cyclone V GX	C5	150	450	300	150	150	150
	C7	156	468	312	156	156	156
	С9	342	1,026	684	342	342	342



Variant	Member Code	Variable- precision DSP Block		dent Input and		18 x 18 Multiplier Adder Mode	18 x 18 Multiplier Adder Summed with 36 bit Input
variant			9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier		
	D5	150	450	300	150	150	150
Cyclone V GT	D7	156	468	312	156	156	156
	D9	342	1,026	684	342	342	342
	A2	36	108	72	36	36	36
Cyclone V	A4	84	252	168	84	84	84
SE	A5	87	261	174	87	87	87
	A6	112	336	224	112	112	112
	C2	36	108	72	36	36	36
Cyclone V	C4	84	252	168	84	84	84
SX	C5	87	261	174	87	87	87
	C6	112	336	224	112	112	112
Cyclone V	D5	87	261	174	87	87	87
ST	D6	112	336	224	112	112	112

Embedded Memory Blocks

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.

Types of Embedded Memory

The Cyclone V devices contain two types of memory blocks:

- 10 Kb M10K blocks—blocks of dedicated memory resources. The M10K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Cyclone V devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB.



Embedded Memory Capacity in Cyclone V Devices

Table 18: Embedded Memory Capacity and Distribution in Cyclone V Devices

	Member	M1	IOK	ML	.AB	
Variant	Code	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Total RAM Bit (Kb)
	A2	176	1,760	314	196	1,956
	A4	308	3,080	485	303	3,383
Cyclone V E	A5	446	4,460	679	424	4,884
	A7	686	6,860	1338	836	7,696
	A9	1,220	12,200	2748	1,717	13,917
	C3	135	1,350	291	181	1,531
	C4	250	2,500	472	295	2,795
Cyclone V GX	C5	446	4,460	679	424	4,884
	C7	686	6,860	1338	836	7,696
	C9	1,220	12,200	2748	1,717	13,917
	D5	446	4,460	679	424	4,884
Cyclone V GT	D7	686	6,860	1338	836	7,696
	D9	1,220	12,200	2748	1,717	13,917
	A2	140	1,400	221	138	1,538
Cyclone V SE	A4	270	2,700	370	231	2,460
Cyclone v 3E	A5	397	3,970	768	480	4,450
	A6	557	5,570	994	621	5,761
	C2	140	1,400	221	138	1,538
Cyclone V SX	C4	270	2,700	370	231	2,460
Cyclone v SA	C5	397	3,970	768	480	4,450
	C6	557	5,570	994	621	5,761
Cyclone V ST	D5	397	3,970	768	480	4,450
Cyclone v 51	D6	557	5,570	994	621	5,761

Embedded Memory Configurations

Table 19: Supported Embedded Memory Block Configurations for Cyclone V Devices

This table lists the maximum configurations supported for the embedded memory blocks. The information is applicable only to the single-port RAM and ROM modes.

Memory Block	Depth (bits)	Programmable Width
MLAB	32	x16, x18, or x20



Memory Block	Depth (bits)	Programmable Width
	256	x40 or x32
	512	x20 or x16
M10K	1K	x10 or x8
WHOK	2K	x5 or x4
	4K	x2
	8K	x1

Clock Networks and PLL Clock Sources

550 MHz Cyclone V devices have 16 global clock networks capable of up to operation. The clock network architecture is based on Altera's global, quadrant, and peripheral clock structure. This clock structure is supported by dedicated clock input pins and fractional PLLs.

Note: To reduce power consumption, the Quartus II software identifies all unused sections of the clock network and powers them down.

PLL Features

The PLLs in the Cyclone V devices support the following features:

- Frequency synthesis
- · On-chip clock deskew
- Jitter attenuation
- Programmable output clock duty cycles
- PLL cascading
- Reference clock switchover
- Programmable bandwidth
- User-mode reconfiguration of PLLs
- Low power mode for each fractional PLL
- Dynamic phase shift
- Direct, source synchronous, zero delay buffer, external feedback, and LVDS compensation modes

Fractional PLL

In addition to integer PLLs, the Cyclone V devices use a fractional PLL architecture. The devices have up to eight PLLs, each with nine output counters. You can use the output counters to reduce PLL usage in two ways:

- Reduce the number of oscillators that are required on your board by using fractional PLLs
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

If you use the fractional PLL mode, you can use the PLLs for precision fractional-N frequency synthesis—removing the need for off-chip reference clock sources in your design.

The transceiver fractional PLLs that are not used by the transceiver I/Os can be used as general purpose fractional PLLs by the FPGA fabric.



FPGA General Purpose I/O

Cyclone V devices offer highly configurable GPIOs. The following list describes the features of the GPIOs:

- Programmable bus hold and weak pull-up
- LVDS output buffer with programmable differential output voltage ($V_{\rm OD}$) and programmable preemphasis
- \bullet On-chip parallel termination (R_T OCT) for all I/O banks with OCT calibration to limit the termination impedance variation
- On-chip dynamic termination that has the ability to swap between series and parallel termination, depending on whether there is read or write on a common bus for signal integrity
- Easy timing closure support using the hard read FIFO in the input register path, and delay-locked loop (DLL) delay chain with fine and coarse architecture

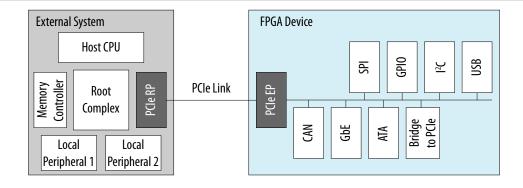
PCIe Gen1 and Gen2 Hard IP

Cyclone V GX, GT, SX, and ST devices contain PCIe hard IP that is designed for performance and ease-of-use. The PCIe hard IP consists of the MAC, data link, and transaction layers.

The PCIe hard IP supports PCIe Gen2 and Gen1 end point and root port for up to x4 lane configuration. The PCIe Gen2 x4 support is PCIe-compatible.

The PCIe endpoint support includes multifunction support for up to eight functions, as shown in the following figure. The integrated multifunction support reduces the FPGA logic requirements by up to 20,000 LEs for PCIe designs that require multiple peripherals.

Figure 9: PCle Multifunction for Cyclone V Devices



The Cyclone V PCIe hard IP operates independently from the core logic. This independent operation allows the PCIe link to wake up and complete link training in less than 100 ms while the Cyclone V device completes loading the programming file for the rest of the device.

In addition, the PCIe hard IP in the Cyclone V device provides improved end-to-end datapath protection using ECC.



External Memory Interface

This section provides an overview of the external memory interface in Cyclone V devices.

Hard and Soft Memory Controllers

Cyclone V devices support up to two hard memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices. Each controller supports 8 to 32 bit components of up to 4 gigabits (Gb) in density with two chip selects and optional ECC. For the Cyclone V SoC devices, an additional hard memory controller in the HPS supports DDR3, DDR2, and LPDDR2 SDRAM devices.

All Cyclone V devices support soft memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices for maximum flexibility.

External Memory Performance

Table 20: External Memory Interface Performance in Cyclone V Devices

The maximum and minimum operating frequencies depend on the memory interface standards and the supported delay-locked loop (DLL) frequency listed in the device datasheet.

Interface	Voltage	Maximum Fre	quency (MHz)	Minimum Frequency (MHz)
interface	(V)	Hard Controller	Soft Controller	willing requestly (wirtz)
DDR3 SDRAM	1.5	400	303	303
DDR3 SDRAM	1.35	400	303	303
DDR2 SDRAM	1.8	400	300	167
LPDDR2 SDRAM	1.2	333	300	167

Related Information

External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Altera's External Memory Interface Spec Estimator tool.

HPS External Memory Performance

Table 21: HPS External Memory Interface Performance

The hard processor system (HPS) is available in Cyclone V SoC devices only.

Interface	Voltage (V)	HPS Hard Controller (MHz)
DDR3 SDRAM	1.5	400
DDR3 SDRAWI	1.35	400
DDR2 SDRAM	1.8	400
LPDDR2 SDRAM	1.2	333



Related Information

External Memory Interface Spec Estimator

For the latest information and to estimate the external memory system performance specification, use Altera's External Memory Interface Spec Estimator tool.

Low-Power Serial Transceivers

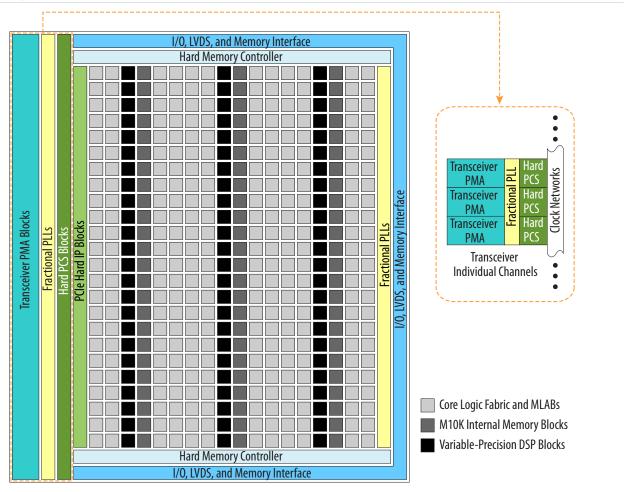
Cyclone V devices deliver the industry's lowest power 6.144 Gbps transceivers at an estimated 88 mW maximum power consumption per channel. Cyclone V transceivers are designed to be compliant with a wide range of protocols and data rates.

Transceiver Channels

The transceivers are positioned on the left outer edge of the device. The transceiver channels consist of the physical medium attachment (PMA), physical coding sublayer (PCS), and clock networks.

Figure 10: Device Chip Overview for Cyclone V GX and GT Devices

The figure shows a Cyclone V FPGA with transceivers. Different Cyclone V devices may have a different floorplans than the one shown here.





PMA Features

To prevent core and I/O noise from coupling into the transceivers, the PMA block is isolated from the rest of the chip—ensuring optimal signal integrity. For the transceivers, you can use the channel PLL of an unused receiver PMA as an additional transmit PLL.

Table 22: PMA Features of the Transceivers in Cyclone V Devices

Features	Capability
Backplane support	Driving capability up to 6.144 Gbps
PLL-based clock recovery	Superior jitter tolerance
Programmable deserialization and word alignment	Flexible deserialization width and configurable word alignment pattern
Equalization and pre-emphasis	 Up to 14.37 dB of pre-emphasis and up to 4.7 dB of equalization No decision feedback equalizer (DFE)
Ring oscillator transmit PLLs	614 Mbps to 6.144 Gbps
Input reference clock range	20 MHz to 400 MHz
Transceiver dynamic reconfiguration	Allows the reconfiguration of a single channel without affecting the operation of other channels

PCS Features

The Cyclone V core logic connects to the PCS through an 8, 10, 16, 20, 32, or 40 bit interface, depending on the transceiver data rate and protocol. Cyclone V devices contain PCS hard IP to support PCIe Gen1 and Gen2, Gbps Ethernet (GbE), Serial RapidIO® (SRIO), and Common Public Radio Interface (CPRI).

Most of the standard and proprietary protocols from 614 Mbps to 6.144 Gbps are supported.

Table 23: Transceiver PCS Features for Cyclone V Devices

PCS Support	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature
3-Gbps and 6-Gbps Basic	0.614 to 6.144	Phase compensation FIFOByte serializer8B/10B encoderTransmitter bit-slip	 Word aligner Deskew FIFO Rate-match FIFO 8B/10B decoder Byte deserializer Byte ordering Receiver phase compensation FIFO



PCS Support	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature
PCIe Gen1 (x1, x2, x4) PCIe Gen2 (x1, x2, x4) ⁽¹⁰⁾	2.5 and 5.0	 Dedicated PCIe PHY IP core PIPE 2.0 interface to the core logic 	 Dedicated PCIe PHY IP core PIPE 2.0 interface to the core logic
GbE	1.25	 Custom PHY IP core with preset feature GbE transmitter synchronization state machine 	 Custom PHY IP core with preset feature GbE receiver synchronization state machine
XAUI (11)	3.125	Dedicated XAUI PHY IP core	Dedicated XAUI PHY IP
HiGig	3.75	XAUI synchronization state machine for bonding four channels	 XAUI synchronization state machine for realigning four channels
SRIO 1.3 and 2.1	1.25 to 3.125	 Custom PHY IP core with preset feature SRIO version 2.1-compliant x2 and x4 channel bonding 	 Custom PHY IP core with preset feature SRIO version 2.1-compliant x2 and x4 deskew state machine
SDI, SD/HD, and 3G-SDI	0.27 ⁽¹²⁾ , 1.485, and 2.97	Custom PHY IP core with preset	Custom PHY IP core with
JESD204A	0.3125 ⁽¹³⁾ to 3.125	feature	preset feature
Serial ATA Gen1 and Gen2	1.5 and 3.0	Custom PHY IP core with preset feature Electrical idle	 Custom PHY IP core with preset feature Signal detect Wider spread of asynchronous SSC



 $^{^{\}left(10\right)}\,$ PCIe Gen2 is supported for Cyclone V GT and ST devices. The PCIe Gen2 x4 support is PCIe-compatible.

⁽¹¹⁾ XAUI is supported through the soft PCS.

⁽¹²⁾ The 0.27-Gbps data rate is supported using oversampling user logic that you must implement in the FPGA fabric.

⁽¹³⁾ The 0.3125-Gbps data rate is supported using oversampling user logic that you must implement in the FPGA fabric.

PCS Support	Data Rates (Gbps)	Transmitter Data Path Feature	Receiver Data Path Feature
CPRI 4.1 ⁽¹⁴⁾	0.6144 to 6.144	Dedicated deterministic	Dedicated deterministic
OBSAI RP3	0.768 to 3.072	latency PHY IP core Transmitter (TX) manual bit-slip mode	latency PHY IP core • Receiver (RX) deterministic latency state machine
V-by-One HS	Up to 3.75		Custom PHY IP core
DisplayPort 1.2 ⁽¹⁵⁾	1.62 and 2.7	Custom PHY IP core	Wider spread of asynchro- nous SSC

SoC with HPS

Each SoC combines an FPGA fabric and an HPS in a single device. This combination delivers the flexibility of programmable logic with the power and cost savings of hard IP in these ways:

- Reduces board space, system power, and bill of materials cost by eliminating a discrete embedded processor
- Allows you to differentiate the end product in both hardware and software, and to support virtually any interface standard
- Extends the product life and revenue through in-field hardware and software updates

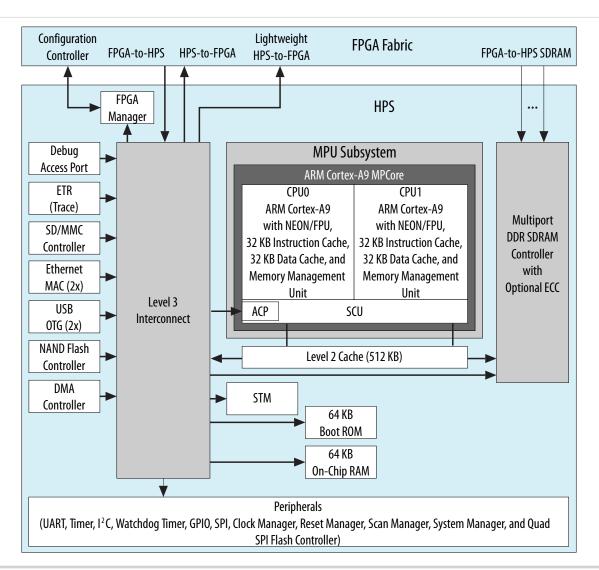
HPS Features

The HPS consists of a dual-core ARM Cortex-A9 MPCore processor, a rich set of peripherals, and a shared multiport SDRAM memory controller, as shown in the following figure.

⁽¹⁴⁾ High-voltage output mode (1000-BASE-CX) is not supported.

⁽¹⁵⁾ Pending characterization.

Figure 11: HPS with Dual-Core ARM Cortex-A9 MPCore Processor



System Peripherals and Debug Access Port

Each Ethernet MAC, USB OTG, NAND flash controller, and SD/MMC controller module has an integrated DMA controller. For modules without an integrated DMA controller, an additional DMA controller module provides up to eight channels of high-bandwidth data transfers. Peripherals that communicate off-chip are multiplexed with other peripherals at the HPS pin level. This allows you to choose which peripherals to interface with other devices on your PCB.

The debug access port provides interfaces to industry standard JTAG debug probes and supports ARM CoreSight debug and core traces to facilitate software development.



HPS-FPGA AXI Bridges

The HPS-FPGA bridges, which support the Advanced Microcontroller Bus Architecture (AMBA[®]) Advanced eXtensible Interface (AXITM) specifications, consist of the following bridges:

- FPGA-to-HPS AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the FPGA fabric to issue transactions to slaves in the HPS.
- HPS-to-FPGA AXI bridge—a high-performance bus supporting 32, 64, and 128 bit data widths that allows the HPS to issue transactions to slaves in the FPGA fabric.
- Lightweight HPS-to-FPGA AXI bridge—a lower latency 32 bit width bus that allows the HPS to issue transactions to slaves in the FPGA fabric. This bridge is primarily used for control and status register (CSR) accesses to peripherals in the FPGA fabric.

The HPS-FPGA AXI bridges allow masters in the FPGA fabric to communicate with slaves in the HPS logic, and vice versa. For example, the HPS-to-FPGA AXI bridge allows you to share memories instantiated in the FPGA fabric with one or both microprocessors in the HPS, while the FPGA-to-HPS AXI bridge allows logic in the FPGA fabric to access the memory and peripherals in the HPS.

Each HPS-FPGA bridge also provides asynchronous clock crossing for data transferred between the FPGA fabric and the HPS.

HPS SDRAM Controller Subsystem

The HPS SDRAM controller subsystem contains a multiport SDRAM controller and DDR PHY that are shared between the FPGA fabric (through the FPGA-to-HPS SDRAM interface), the level 2 (L2) cache, and the level 3 (L3) system interconnect. The FPGA-to-HPS SDRAM interface supports AMBA AXI and Avalon® Memory-Mapped (Avalon-MM) interface standards, and provides up to six individual ports for access by masters implemented in the FPGA fabric.

To maximize memory performance, the SDRAM controller subsystem supports command and data reordering, deficit round-robin arbitration with aging, and high-priority bypass features. The SDRAM controller subsystem supports DDR2, DDR3, or LPDDR2 devices up to 4 Gb in density operating at up to 400 MHz (800 Mbps data rate).

FPGA Configuration and Processor Booting

The FPGA fabric and HPS in the SoC are powered independently. You can reduce the clock frequencies or gate the clocks to reduce dynamic power, or shut down the entire FPGA fabric to reduce total system power.

You can configure the FPGA fabric and boot the HPS independently, in any order, providing you with more design flexibility:

- You can boot the HPS independently. After the HPS is running, the HPS can fully or partially reconfigure the FPGA fabric at any time under software control. The HPS can also configure other FPGAs on the board through the FPGA configuration controller.
- You can power up both the HPS and the FPGA fabric together, configure the FPGA fabric first, and then boot the HPS from memory accessible to the FPGA fabric.

Note: Although the FPGA fabric and HPS are on separate power domains, the HPS must remain powered up during operation while the FPGA fabric can be powered up or down as required.



Related Information

Cyclone V Device Family Pin Connection Guidelines

Provides detailed information about power supply pin connection guidelines and power regulator sharing.

Hardware and Software Development

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Qsys system integration tool in the Quartus II software.

For software development, the ARM-based SoC devices inherit the rich software development ecosystem available for the ARM Cortex-A9 MPCore processor. The software development process for Altera SoCs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux, VxWorks®, and other operating systems is available for the SoCs. For more information on the operating systems support availability, contact the Altera sales team.

You can begin device-specific firmware and software development on the Altera SoC Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board that runs on a PC. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

Related Information

Altera Worldwide Sales Support

Dynamic and Partial Reconfiguration

The Cyclone V devices support dynamic reconfiguration and partial reconfiguration (16).

Dynamic Reconfiguration

The dynamic reconfiguration feature allows you to dynamically change the transceiver data rates, PMA settings, or protocols of a channel, without affecting data transfer on adjacent channels. This feature is ideal for applications that require on-the-fly multiprotocol or multirate support. You can reconfigure the PMA and PCS blocks with dynamic reconfiguration.

Partial Reconfiguration

Note: Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Altera for support.

Partial reconfiguration allows you to reconfigure part of the device while other sections of the device remain operational. This capability is important in systems with critical uptime requirements because it allows you to make updates or adjust functionality without disrupting services.

Apart from lowering cost and power consumption, partial reconfiguration increases the effective logic density of the device because placing device functions that do not operate simultaneously is not necessary. Instead, you can store these functions in external memory and load them whenever the functions are

Cyclone V Device Overview



⁽¹⁶⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Altera for support.

required. This capability reduces the size of the device because it allows multiple applications on a single device—saving the board space and reducing the power consumption.

Altera simplifies the time-intensive task of partial reconfiguration by building this capability on top of the proven incremental compile and design flow in the Quartus II design software. With the Altera® solution, you do not need to know all the intricate device architecture details to perform a partial reconfiguration.

Partial reconfiguration is supported through the FPP x16 configuration interface. You can seamlessly use partial reconfiguration in tandem with dynamic reconfiguration to enable simultaneous partial reconfiguration of both the device core and transceivers.

Enhanced Configuration and Configuration via Protocol

Cyclone V devices support 1.8 V, 2.5 V, 3.0 V, and 3.3 V programming voltages and several configuration modes.

Table 24: Configuration Modes and Features Supported by Cyclone V Devices

Mode	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompres- sion	Design Security	Partial Reconfigu- ration ⁽¹⁷⁾	Remote System Update
AS through the EPCS and EPCQ serial configuration device	1 bit, 4 bits	100	_	Yes	Yes	_	Yes
PS through CPLD or external microcontroller	1 bit	125	125	Yes	Yes	_	_
FPP	8 bits	125	_	Yes	Yes	_	Parallel flash loader
111	16 bits	125	_	Yes	Yes	Yes	r araner nasn toader
CvP (PCIe)	x1, x2, and x4 lanes	_	_	Yes	Yes	Yes	_
JTAG	1 bit	33	33	_	_	_	_

Instead of using an external flash or ROM, you can configure the Cyclone V devices through PCIe using CvP. The CvP mode offers the fastest configuration rate and flexibility with the easy-to-use PCIe hard IP block interface. The Cyclone V CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.



⁽¹⁷⁾ Partial reconfiguration is an advanced feature of the device family. If you are interested in using partial reconfiguration, contact Altera for support.

Related Information

Configuration via Protocol (CvP) Implementation in Altera FPGAs User Guide Provides more information about CvP.

Power Management

Leveraging the FPGA architectural features, process technology advancements, and transceivers that are designed for power efficiency, the Cyclone V devices consume less power than previous generation Cyclone FPGAs:

- Total device core power consumption—less by up to 40%.
- Transceiver channel power consumption—less by up to 50%.

Additionally, Cyclone V devices contain several hard IP blocks that reduce logic resources and deliver substantial power savings of up to 25% less power than equivalent soft implementations.



Document Revision History

Date	Version	Changes
January 2015	2015.01.23	• Updated Sample Ordering Code and Available Options for Cyclone V ST Devices figure because Cyclone V ST devices are only available in I temperature grade and –7 speed grade.
		 Operating Temperature: Removed C and A temperature grades FPGA Fabric Speed Grade: Removed -6 and -8 speed grades Updated the transceiver specification for Cyclone V ST from 5 Gbps to 6.144 Gbps:
		 Device Variants for the Cyclone V Device Family table Sample Ordering Code and Available Options for Cyclone V ST Devices figure Maximum Resource Counts for Cyclone V ST Devices Updated Maximum Resource Counts for Cyclone V GX Devices table for Cyclone V GX G3 devices.
		 Logic elements (LE) (K): Updated from 35.7 to 35.5 Variable-precision DSP block: Updated from 51 to 57 18 x 18 multiplier: Updated from 102 to 114 Updated Number of Multipliers in Cyclone V Devices table for Cyclone V GX G3 devices.
		 Variableprecision DSP Block: Updated from 51 to 57 9 x 9 Multiplier: Updated from 153 to 171 18 x 18 Multiplier: Updated from 102 to 114 27 x 27 Multiplier: Updated from 51 to 57 18 x 18 Multiplier Adder Mode: Updated from 51 to 57 18 x 18 Multiplier Adder Summed with 36 bit Input: Updated from 51 to 57 Updated Embedded Memory Capacity and Distribution in Cyclone V Devices table for Cyclone V GX G3 devices.
		 M10K block: Updated from 119 to 135 M10K RAM bit (Kb): Updated from 1,190 to 1,350 MLAB block: Updated from 255 to 291 MLAB RAM bit (Kb): Updated from 159 to 181 Total RAM bit (Kb): Updated from 1,349 to 1,531
October 2014	2014.10.06	Added a footnote to the "Transceiver PCS Features for Cyclone V Devices" table to show that PCIe Gen2 is supported for Cyclone V GT and ST devices.
July 2014	2014.07.07	Updated the I/O vertical migration figure to clarify the migration capability of Cyclone V SE and SX devices.



Date	Version	Changes
December 2013	2013.12.26	 Corrected single or dual-core ARM Cortex-A9 MPCore processor-up to 925 MHz from 800 MHz. Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables. Removed the note "The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os." for GPIOs in the Maximum Resource Counts table for Cyclone V E and SE. Added link to Altera Product Selector for each device variant. Updated Embedded Hard IPs for Cyclone V GT devices to indicate Maximum 2 hard PCIe and 2 hard memory controllers. Added leaded package options. Removed the note "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table. Corrected max LVDS counts for transmitter and receiver for Cyclone V E A5 device from 84 to 60. Corrected max LVDS counts for transmitter and receiver for Cyclone V E A9 device from 140 to 120. Corrected variable-precision DSP block, 27 x 27 multiplier, 18 x 18 multiplier adder mode and 18 x 18 multiplier adder summed with 36 bit input for Cyclone V SE devices from 58 to 84. Corrected 18 x 18 multiplier for Cyclone V SE devices from 116 to 168. Corrected 1VDS transmitter for Cyclone V SE devices from 174 to 252. Corrected LVDS reasimitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32. Corrected transceiver speed grade for Cyclone V ST devices ordering code from 4 to 5. Updated the DDR3 SDRAM for the maximum frequency's soft controller and the minimum frequency from 300 to 303 for voltage 1.35V. Added links to Altera's External Memory Spec Estimator tool to the topics listing the external memory interface performance. Corrected XAUI is supported through the soft PCS in the PCS features for Cyclone V. Added decompression support for the



Date	Version	Changes
May 2013	2013.05.06	 Added link to the known document issues in the Knowledge Base. Moved all links to the Related Information section of respective topics for easy reference. Corrected the title to the PCIe hard IP topic. Cyclone V devices support only PCIe Gen1 and Gen2. Updated Supporting Feature in Table 1 of Increased bandwidth capacity to '6.144 Gbps'. Updated Description in Table 2 of Low-power high-speed serial interface to '6.144 Gbps'. Updated Description in Table 3 of Cyclone V GT to '6.144 Gbps'. Updated the M386 package to M383 for Figure 1, Figure 2 and Figure 3. Updated Figure 2 and Figure 3 for Transceiver Count by adding 'F: 4'. Updated LVDS in the Maximum Resource Counts tables to include Transmitter and Receiver values. Updated the package plan with M383 for the Cyclone V E device. Removed the M301 and M383 packages from the Cyclone V GX C4 device. Updated the GPIO count to '129' for the M301 package of the Cyclone V GX C5 device. Updated TPS I/O for U484 (19 mm) in Table 11 with '151' for A2, A4, A5 and A6. Updated Memory (Kb) for Maximum Resource Counts for Cyclone V SE A4 and A6, SX C4 and C6, ST D6 devices. Updated PPGA PLL for Maximum Resource Counts for Cyclone V SE A4 and A6, SX C4 and C6, ST D6 devices. Updated Variable-precision DSP Blocks and 18 x 18 Multiplier for Maximum Resource Counts for Cyclone V SE A5 (20 devices). Updated Table 17 for Cyclone V SX C4 device. Updated Embedded Memory Capacity and Distribution table for Cyclone V SE A4 and A6, SX C4 and C6, ST D6 devices. Updated Embedded Memory Capacity and Distribution table for Cyclone V SE A4 and A6, SX C4 and C6, ST D6 devices. Updated Embedded Memory Capacity and Distribution table for Cyclone V SE A4 and A6, SX C4 and C6, ST D6 devices. Removed 'Counter reconfiguration' from the PLL Features. Updated Low-Power Serial Transceivers by replacing 5 Gb



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Date	Version	Changes
		 Updated Capability in Table 22 of Ring oscillator transmit PLLs with 6.144 Gbps. Updated the PCS Support in Table 23 from 5 Gbps to '6 Gbps'. Updated the Data Rates (Gbps) in Table 23 of 3 Gbps and 6 Gbps Basic to '6.144 Gbps'. Updated the Data Rates (Gbps) in Table 23 of CPRI 4.1 to '6.144 Gbps'. Clarified that partial reconfiguration is an advanced feature. Contact Altera for support of the feature.
December 2012	2012.12.28	 Updated the pin counts for the MBGA packages. Updated the GPIO and transceiver counts for the MBGA packages. Updated the GPIO counts for the U484 package of the Cyclone V E A9, GX C9, and GT D9 devices. Updated the vertical migration table for vertical migration of the U484 packages. Updated the MLAB supported programmable widths at 32 bits depth.
November 2012	2012.11.19	 Added new MBGA packages and additional U484 packages for Cyclone V E, GX, and GT. Added ordering code for five-transceiver devices for Cyclone V GT and ST. Updated the vertical migration table to add MBGA packages. Added performance information for HPS memory controller. Removed DDR3U support. Updated Cyclone V ST speed grade information. Added information on maximum transceiver channel usage restrictions for PCI Gen2 and CPRI at 4.9152 Gbps transmit jitter compliance. Added note on the differences between GPIO reported in Overview with User I/O numbers shown in the Quartus II software. Updated template.
July 2012	2.1	Added support for PCIe Gen2 x4 lane configuration (PCIe-compatible)



Date	Version	Changes
June 2012	2.0	 Restructured the document. Added the "Embedded Memory Capacity" and "Embedded Memory Configurations" sections. Added Table 1, Table 3, Table 16, Table 19, and Table 20. Updated Table 2, Table 4, Table 5, Table 6, Table 7, Table 8, Table 9, Table 10, Table 11, Table 12, Table 13, Table 14, Table 17, and Table 18. Updated Figure 1, Figure 2, Figure 3, Figure 4, Figure 5, Figure 6, and Figure 10. Updated the "FPGA Configuration and Processor Booting" and "Hardware and Software Development" sections. Text edits throughout the document.
February 2012	1.2	 Updated Table 1–2, Table 1–3, and Table 1–6. Updated "Cyclone V Family Plan" on page 1–4 and "Clock Networks and PLL Clock Sources" on page 1–15. Updated Figure 1–1 and Figure 1–6.
November 2011	1.1	 Updated Table 1–1, Table 1–2, Table 1–3, Table 1–4, Table 1–5, and Table 1–6. Updated Figure 1–4, Figure 1–5, Figure 1–6, Figure 1–7, and Figure 1–8. Updated "System Peripherals" on page 1–18, "HPS–FPGA AXI Bridges" on page 1–19, "HPS SDRAM Controller Subsystem" on page 1–19, "FPGA Configuration and Processor Booting" on page 1–19, and "Hardware and Software Development" on page 1–20. Minor text edits.
October 2011	1.0	Initial release.



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5CSEBA5U19A7N 5CSEBA5U19C6N 5CSEBA5U19C7N 5CSEBA5U19C7SN 5CSEBA5U19C8N 5CSEBA5U19C8SN 5CSEBA5U19I7N 5CSEBA5U19I7SN 5CSEBA5U23A7N 5CSEBA5U23C6N 5CSEBA5U23C7N 5CSEBA5U23C7SN 5CSEBA5U23C8N 5CSEBA5U23C8SN 5CSEBA5U23I7N 5CSEBA5U23I7SN 5CSEBA6U19A7N 5CSEBA6U19C6N 5CSEBA6U19C7N 5CSEBA6U19C7SN 5CSEBA6U19C8N 5CSEBA6U19C8NES 5CSEBA6U19C8SN 5CSEBA6U19I7N 5CSEBA6U19I7SN 5CSEBA6U23A7N 5CSEBA6U23C6N 5CSEBA6U23C7N 5CSEBA6U23C7SN 5CSEBA6U23C8N 5CSEBA6U23C8SN 5CSEBA6U23I7N 5CSEBA6U23I7SN 5CSEMA5F31A7N 5CSEMA5F31C6N 5CSEMA5F31C7N 5CSEMA5F31C8N 5CSEMA5F31I7N 5CSEMA5U23A7N 5CSEMA5U23C6N 5CSEMA5U23C7N 5CSEMA5U23C8N 5CSEMA5U23I7N 5CSEMA6F31A7N 5CSEMA6F31C6N 5CSEMA6F31C7N 5CSEMA6F31C8N 5CSEMA6F31I7N 5CSEMA6U23A7N 5CSEMA6U23C6N 5CSEMA6U23C7N 5CSEMA6U23C8N 5CSEMA6U23I7N 5CSTFD5D5F31I7N 5CSTFD6D5F31I7N 5CSXFC5C6U23A7N 5CSXFC5C6U23C6N 5CSXFC5C6U23C7N 5CSXFC5C6U23C8N 5CSXFC5C6U23I7N 5CSXFC5D6F31C6N 5CSXFC5D6F31C7N 5CSXFC5D6F31C8N 5CSXFC5D6F31I7N 5CSXFC6C6U23A7N 5CSXFC6C6U23C6N 5CSXFC6C6U23C7N 5CSXFC6C6U23C8N 5CSXFC6C6U23I7N 5CSXFC6D6F31C6N 5CSXFC6D6F31C7N 5CSXFC6D6F31C8N 5CSXFC6D6F31I7N 5CGXBC4C6F23C7N 5CEFA5F23C8N 5CEFA7F31I7N 5CGXFC9E7F31C8N 5CGTFD9E5F35I7N 5CGXFC5C6U19A7N 5CGXFC7D6F31C6N 5CGTFD5C5F23I7 5CEBA9F23C8N 5CGTFD9E5F31C7N 5CEFA7U19I7 5CEFA7F31C7N 5CEFA2F23C6N 5CEFA7M15C7N 5CEFA5M13C6N 5CGXFC3B7U19C8N 5CGXFC7B6M15I7N 5CGXFC7C6F23I7N 5CGXBC9C7F23C8N 5CGXFC9C6F23I7N 5CEBA2F17C8N 5CEBA9F31C7N 5CGTFD7D5F27I7N 5CGXFC4F7M11C8N 5CGXFC9D6F27I7N 5CGXBC4C7F23C8N 5CGXFC3B6U15A7N